



Praetorian III[®] EMI Filter for T-Flash/MicroSD Interfaces

CM1624

Features

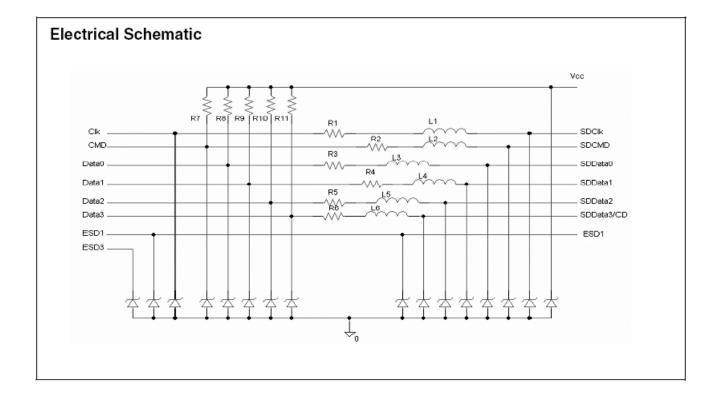
- Bidirectional EMI/RFI filtering and line termination with integrated ESD protection
- Provides ESD protection to IEC61000-4-2:
 - ±15kV contact discharge
- TVS working voltage: 5V
- Termination resistors: 40Ω
- Pull-up resistors: 25kΩ
- Typical capacitance per line: 12pF (V_{IN}= 2.5V)
- Protection and termination for six lines + Vcc
- Solid-state technology

Applications

- T-Flash / MicroSD interfaces
- MMC interfaces
- CDMA, GSM, 3G cell phones

Mechanical Characteristics

- 0.40mm, uDFN 16-pin package
- RoHS/WEEE compliance, lead-free finish
- Nominal dimensions: 3.30 x 1.35 x 0.50mm
- Pitch: 0.4mm
- Pin-lead finish: NiPd



Description

The CM1624 is a combination EMI filter and line termination device with integrated TVS diodes for use on Multimedia Card interfaces. This state-of-the-art device utilizes solid-state, silicon-avalanche technology for superior clamping performance and DC electrical characteristics. The CM1624 has been optimized for protection of T-Flash/MicroSD interfaces in cellular phones and other portable electronics.

The CM1624 consists of six circuits that includes series impedance matching resistors and pull-up resistors as required by the SD specification. TVS diodes are included on each line for ESD protection. An additional TVS diode connection is included for protection of the voltage (Vcc) bus. Termination resistor value of 40Ω is provided on the SDData0, SDData1, SDData2, SDData3, CMD, and CLK lines.

Pull-up resistors of $25k\Omega$ are included on the SDData0, SDData1, SDData2, SDData3 and CMD lines, as well. These may be configured for devices operating in SD or SPI mode. The TVS diodes provide effective suppression of ESD voltages in excess of ±15kV (contact discharge) per IEC 61000-4-2, level 4. The CM1624 is in a 16-pin, RoHS/WEEE compliant, UDFN 16-pin package. It measures 3.30 x 1.35 x 0.50mm. The leads are spaced at a pitch of 0.4mm and are finished with lead-free NiPd.

Package/Pin Information

PACKAGE / PINOUT DIAGRAMS								
Top View								
SDData1		Data1						
SDData0		Data0						
SDCLK		CLK						
ESD1		ESD1						
ESD3	$\begin{bmatrix} 4 \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\ - \\$	VCC						
SDCMD		СМД						
SDData3		Data3						
SDData2		Data2						
	L							
Note: 1) This drawing is not to scale.								

PIN DESCRIPTIONS					
Pin	Name	Description			
1	SDData1	Data line #1 input/output with pull-up resistor			
2	SDData0	Data line #0 input/output with pull-up resistor			
3	SDCLK	Clock line Input/Output			
4	ESD1	Single ESD			
5	ESD3	Single ESD			
6	SDCMD	Command Line Input/Output			
7	SDData3	Data line #3 input/output with pull-up resistor			
8	SDData2	Data line #2 input/output with pull-up resistor			
9	Data2	Data line #2 input/output with pull-up resistor			
10	Data3	Data line #3 input/output with pull-up resistor			
11	CMD	Command Line Input/Output			
12	VCC	Power Supply ESD Protection			
13	ESD1	Single ESD			
14	CLK	Clock line Input/Output			
15	Data0	Data line #0 input/output with pull-up resistor			
16	Data1	Data line #1 input/output with pull-up resistor			
GND PAD	GND	Ground return to shield			

Ordering Information

PART NUMBERING INFORMATION (Note 1)						
PIN	PACKAGE	LEAD-FREE FINISH	Part Marking			
16	uDFN-16 (0.40mm)	CM1624 -08DE	1624(x) (Note 2)			

Note 1: Parts are shipped in Tape and Reel form unless otherwise specified. Note 2: (x) = single character date code.

Specifications

ABSOLUTE MAXIMUM RATINGS*						
PARAMETER	RATING	UNITS				
Operating Temperature Range	-40 to +85	°C				
Storage Temperature Range	-55 to +150	°C				

*Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1)									
SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	МАХ	UNITS			
R _{ch}	Channel Resistance (R1 to R6)		34	40	46	Ω			
L _{ch}	Channel Inductance			20		nH			
С	Capacitance per Channel	V _{IN} = 0V; 1MHz; 30mV _{RMS}	16	20	24	pF			
		V _{IN} = 2.5V; 1MHz; 30mV _{RMS;}		12		pF			
R _{up}	Pull-up Resistance (R7 to R11)		21	25	29	kΩ			
I _{leak}	Diode Leakage Current per Channel	V _{IN} = 3V		0.1	0.5	μA			
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	$I_{LOAD} = 10mA$ $I_{LOAD} = -10mA$	5.6 -1.5	6.8 -0.8	9.0 -0.4	V V			
V _{ESD}	ESD Protection - Peak Discharge Voltage at any channel input, in system: a) Contact discharge per IEC 61000-4-2 Standard and b) Air discharge per IEC 61000-4-2 Standard		±15 ±15			kV kV			
f _c	Cut-off frequency $Z_{SOURCE} = 50\Omega, Z_{LOAD} = 50\Omega$			300		MHz			

Note 1: All parameters specified at $T_{A} = 25^{\circ}C$ unless otherwise noted.

Performance Information

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Environment)

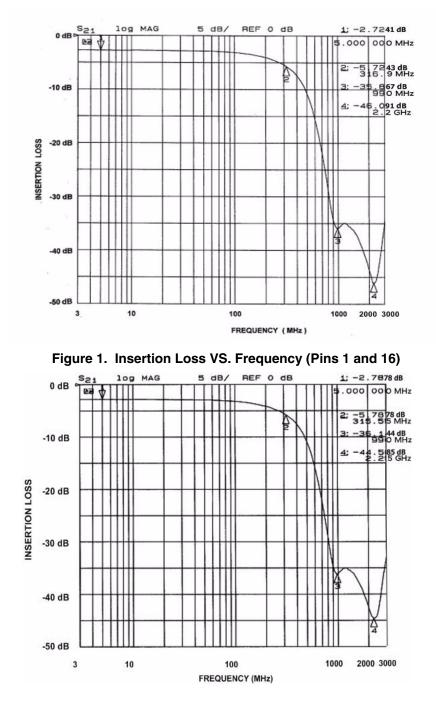


Figure 2. Insertion Loss VS. Frequency (Pins 2 and 15)

Performance Information (cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 50Ω Environment)

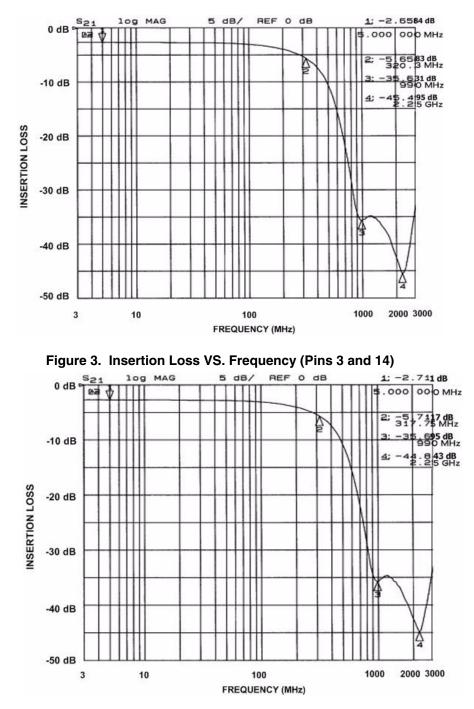
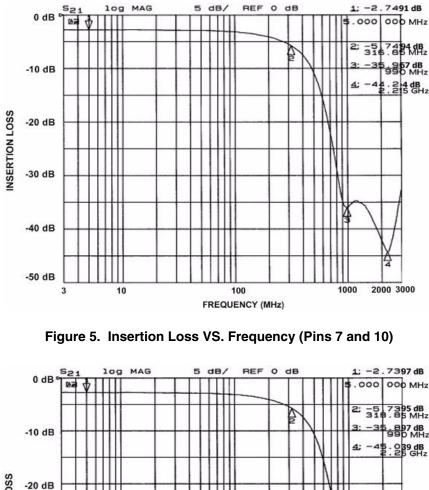


Figure 4. Insertion Loss VS. Frequency (Pins 6 and 11)

Performance Information (cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Environment)



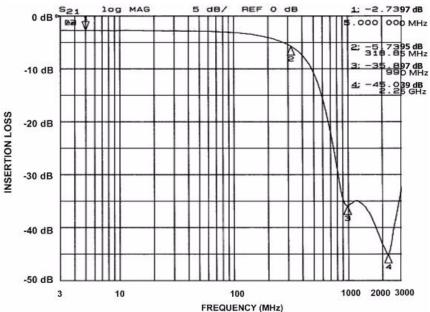


Figure 6. Insertion Loss VS. Frequency (Pins 8 and 9)

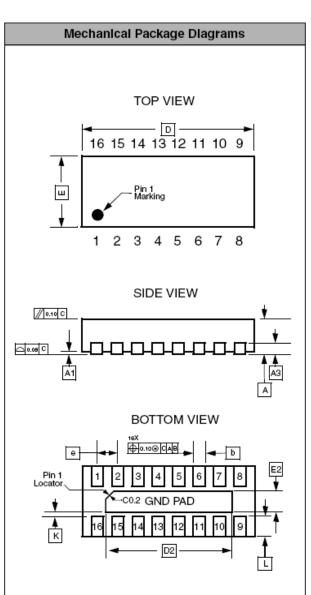
Mechanical Details

uDFN-16 Mechanical Specifications, 0.4mm

The 16-lead, 0.4mm pitch uDFN package dimensions are presented below.

PACKAGE DIMENSIONS									
Package	uDFN								
JEDEC No.		MO-229C*							
Leads			1	16					
Dim.	Millimeters				Inches				
Dini.	Min	Nom	Max	Min	Nom	Max			
Α	0.45	0.50	0.55	0.018	0.020	0.022			
A1	0.00	0.02	0.05	0.000	0.001 0.002				
A3	0.127 REF			0.005 REF					
b	0.15	0.20	0.25	0.006 0.008 0.0					
D	3.20	3.30	3.40	0.126	0.130	0.134			
D2	2.70	2.80	2.90	0.106	0.110	0.114			
E	1.25	1.35	1.45	0.049	0.053	0.057			
E2	0.30	0.40	0.50	0.012	0.012 0.016 0.0				
е	0.40 BSC			0.016 BSC					
к	0.22 REF			0.009 REF					
L	0.15	0.25	0.35	0.006	0.010	0.014			
# per tape and reel	3000 pieces								
	Contro	olling din	nension:	millime	ters				

^{*}This package is compliant with JEDEC standard MO-229C with the exception of the D, D2, E, E2, K and L dimensions as called out in the table above.

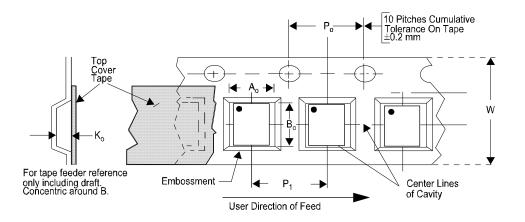


Dimensions for 16-Lead, 0.4mm pitch uDFN package

CM1624

Tape and Reel Specifications

PART NUMBER	PACKAGE SIZE (mm)	POCKET SIZE (mm) B _o X A _o X K _o	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P₀	P₁
CM1624 -08DE	3.30 X 1.35 X 0.50	3.50 X 1.55 X 0.70	12mm	178mm (7")	3000	4mm	4mm



CM1624

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